

#### LOW CAPACITANCE BIDIRECTIONAL TVS DIODE

#### **Features**

- Provides ESD Protection per IEC 61000-4-2 Standard: Air – ±30kV, Contact – ±30kV
- Ultra Low Profile (0.4mm), Ideal for Thin Portable Electronics
- 1 Channel of ESD Protection
- Low Channel Input Capacitance
- Typically Used in Cellular Handsets, Portable Electronics, Communication Systems, Computers and Peripherals
- Lead Free/RoHS Compliant (Note 1)
- "Green" Device (Note 2)

X2-DFN1006-2

### **Mechanical Data**

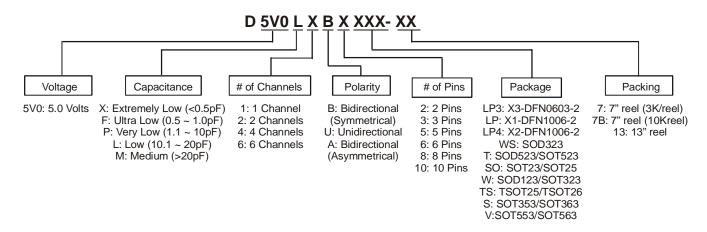
- Case: X2-DFN1006-2
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: NiPdAu over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.001 grams (approximate)



**Bottom View** 

**Device Schematic** 

### Ordering Information (Note 3)



Part Number	Case	Packaging	
D5V0L1B2LP4-7B	X2-DFN1006-2	10,000/Tape & Reel	

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. No purposely added lead. Halogen and Antimony free.
- 2. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com.
- 3. For packaging details, go to our website at http://www.diodes.com.

## **Marking Information**

z

Z = Product Type Marking Code Line Denotes Pin 1



## Maximum Ratings @T<sub>A</sub> = 25℃ unless otherwise specified

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Power Dissipation	P <sub>PP</sub>	84	W	8/20μs, Per Fig. 1
Peak Pulse Current	I <sub>PP</sub>	6	Α	8/20μs, Per Fig. 1
ESD Protection – Contact Discharge	V <sub>ESD_Contact</sub>	±30	kV	IEC 61000-4-2 Standard
ESD Protection – Air Discharge	$V_{ESD\_Air}$	±30	kV	IEC 61000-4-2 Standard

### **Thermal Characteristics**

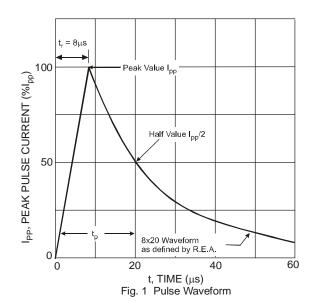
Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 4)	P <sub>D</sub>	250	mW
Thermal Resistance, Junction to Ambient (Note 4)	$R_{ hetaJA}$	500	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

## Electrical Characteristics @TA = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Standoff Voltage	V <sub>RWM</sub>	-	-	5	V	-
Channel Leakage Current (Note 5)	I <sub>RM</sub>	-	10	100	nA	$V_{RWM} = 5V$
Clamping Voltage, Positive Transients	V <sub>CL</sub>		7.0 9.0 10.5 11.5	9.0 11.0 12.0 14.0	V	$\begin{split} &\text{Ipp} = 1\text{A, } t_p = 8/20\mu\text{S} \\ &\text{Ipp} = 3.5\text{A, } t_p = 8/20\mu\text{S} \\ &\text{Ipp} = 5\text{A, } t_p = 8/20\mu\text{S} \\ &\text{Ipp} = 5\text{A, } t_p = 8/20\mu\text{S} \\ &\text{Ipp} = 6\text{A, } t_p = 8/20\mu\text{S} \end{split}$
Breakdown Voltage	$V_{BR}$	6	7	8	V	$I_R = 1 \text{mA}$
Differential Resistance	R <sub>DIF</sub>	-	0.2	-	Ω	$I_R = 1A$ , $t_p = 8/20 \mu S$
Channel Input Capacitance	C <sub>T</sub>	-	15	20	pF	$V_R = 0V$ , $f = 1MHz$

Notes:

- 4. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at http://www.diodes.com.
- 5. Short duration pulse test used to minimize self-heating effect.



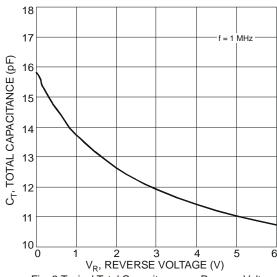
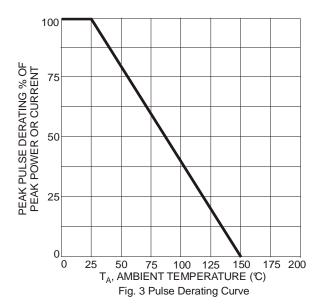
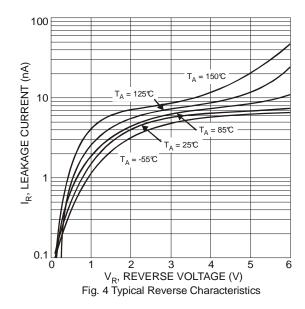


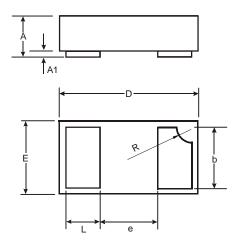
Fig. 2 Typical Total Capacitance vs. Reverse Voltage





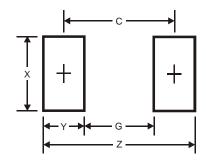


## **Package Outline Dimensions**



X2-DFN1006-2				
Dim	Min	Max	Тур	
Α	0.34	0.4	0.37	
A1	0	0.05	0.03	
b	0.45	0.55	0.50	
D	0.95	1.075	1.00	
E	0.55	0.675	0.60	
E			0.40	
L	0.20	0.30	0.25	
R	0.05	0.15	0.10	
All Dimensions in mm				

# **Suggested Pad Layout**



Dimensions	Value (in mm)
Z	1.1
G	0.3
Х	0.7
Y	0.4
С	0.7



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